

AMENDMENTS TO THE DRAWINGS:

FIG. 1, amend the description in step 101 as follows:

choosing all the points to be tested on the ~~[[print]]~~ printed circuit board by software

FIG. 1, amend the description in step 102 as follows:

making a ~~print circuit~~ printed circuit board having protruding metal points

FIG. 1, amend the description in step 103 as follows:

connecting all the metal points to holes for connection members located at a side of the ~~[[print]]~~ printed circuit board by way of layout

FIG. 1, amend the description in step 106 as follows:

aligning the points to be tested on the ~~[[print]]~~ printed circuit board with the protruding metal points

FIG. 1, amend the description in step 107 as follows:

using the pressure from the press of the tester to contact the protruding metal points and points to be tested on the ~~[[print]]~~ printed circuit board

FIG. 2, amend the description in step 101 as follows:

choosing all the points to be tested on the ~~[[print]]~~ printed circuit board by software

FIG. 2, amend the description in step 102 as follows:

making a ~~print circuit~~ printed circuit board having protruding metal points

FIG. 2, amend the description in step 103 as follows:

connecting all the metal points to holes for connection members located at a side of the ~~[[print]]~~ printed circuit board by way of layout

FIG. 2, amend the description in step 205 as follows:

inserting a pressure ~~inductive~~ sensitive conductive rubber layer between the protruding metal ~~[[point]]~~ points and the points to be tested on the ~~[[print]]~~ printed circuit board

FIG. 2, amend the description in step 206 as follows:

using the press of the tester to apply a pressure to the ~~inductive~~ pressure sensitive conductive rubber via the protruding metal ~~[[point]]~~ points and the points to be tested on the ~~[[print]]~~ printed circuit board to make them ~~[[to be]]~~ electrically connected

FIG. 3, amend the description in step 101 as follows:

choosing all the points to be tested on the ~~[[print]]~~ printed circuit board by software

FIG. 3, amend the description in step 102 as follows:

making a ~~print circuit~~ printed circuit board having protruding metal points

FIG. 3, amend the description in step 103 as follows:

connecting all the metal points to holes for connection members located at a side of the ~~[[print]]~~ printed circuit board by way of layout

FIG. 3, amend the description in step 305 as follows:

~~connecting conductive rubber~~ taping an electrically z-axis conductive adhesive film to a tip of each metal point and ensuring that the conductive adhesive film is electrically connected with the metal point

FIG. 3, amend the description in step 306 as follows:

aligning the points to be tested on the ~~[[print]]~~ printed circuit board with the protruding metal points

FIG. 3, amend the descriptions in step 307 as follows:

using the pressure from the press of the tester ~~and tests~~ to electrically connect the metal points and points to be tested on the ~~[[print]]~~ printed circuit board to the conductive

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~~rubber~~ adhesive film